Effects of the Post-Deposition Annealing Treatment on the Electrochemical Behavior of TiN Coatings Deposited by CAE-PVD Method

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Abstract: The main purpose of this investigation was to assess the effect of post-deposition annealing treatment on the electrochemical behavior of TiN coating developed on AISI 304 stainless steel substrate using cathodic arc evaporation physical vapor deposition (CAE-PVD). Post-annealing treatment at 400ºC was performed on the coated substrate for 1 h. The studied samples were characterized using X-ray diffraction (XRD), scanning electron microscope (SEM), potentiodynamic polarization (PDP), and electrochemical impedance spectroscopy (EIS) tests. The preferred orientation of TiN (111) was verified by XRD patterns. The crystallinity of the coating was increased after annealing treatment. SEM observations indicated that TiN coatings free of cracks were developed on the substrate. The electrochemical measurements elucidated that the annealed coating had better corrosion resistance compared to that of the as-deposited coating with a lower current corrosion density. This investigation implies that improved corrosion performance of the TiN coating can be achieved by performing post-deposition annealing treatment.

Keywords: post-deposition annealing, electrochemical behavior, TiN coating, CAE-PVD, EIS.

1. INTRODUCTION

In recent years, among the numerous coatings available on the market, nitride-based coatings such as titanium nitride (TiN) are extensively used to improve the electrochemical, mechanical, and tribological properties of the coated tools. TiN is one of the first transition nitride coatings that has gained a lot of interest from researchers, because of its properties including high corrosion resistance, hardness, and wear resistance, and is deposited on the surfaces of medical implants [1, 2], mechanical, and industrial components [3–6]. In a nutshell, the deposition of TiN results in amelioration of the superficial properties [7–14], the functionality of the parts (electrical, optical, etc.), and esthetical finishing of the components by giving a yellow-gold luster [15–18]. The properties displayed by the nitride coating are attributed to the type of elements, the quantity of the elements, and the deposition parameters used during coating deposition by CAE-PVD [19]. Because of the high deposition rate and good adhesion of the coating to the substrate, the CAE-PVD technique is extensively used to deposit nitride coating. Although this technique is an efficient deposition method, however, it introduces some intrinsic defects which can be detrimental to the functionality of the coatings. In CAE-PVD, a continuous or pulsed electric current at low voltage is passed between the cathode and anode electrode resulting in the evaporation target material (cathode). The evaporated materials are deposited on the substrates in the form of atoms, molecules, and micro-droplets, and the latter resulting in formation of the macro-particles [20]. The macro-particles can be detached from the surface, leading to the formation of the preferred diffusive paths through the coating to the substrates [21]. During deposition by CAE-PVD, the substrate and the coating materials are heated to a specific temperature. Since the substrate and the coating are made up of different alloys, this phenomenon can cause different thermal coefficients and lattice mismatch between the coatings and the substrates [22]. The difference in the thermal coefficients will result in the formation of residual stress. Certain properties such as adhesion, hardness, and corrosion resistance of the coatings are impressed affected by the residual stresses created during the CAE-PVD process [20, 23]. Although nitride coatings have been proven to have good properties, researchers are still investigating ways to improve the mechanical, tribological, and corrosion resistance of nitride CAE-PVD coatings [24]. Proposals to achieve a superior coating include...
finding the optimal deposition parameters during the CAE-PVD process (i.e., arc current, voltage, and temperature) [25], treatment of the substrate before deposition (pre-deposition treatment) [26], treatment of the coatings during deposition (intermediate treatment) [27], and after deposition treatment (post-deposition treatment) [28].

One of the post-deposition treatments on monolayer coatings that has gained a lot of interest in recent years is annealing [12, 29–37]. Hsu et al. [38], by depositing a TiN coating on AISI 316L stainless steel substrate (using CAE-PVD), observed that annealing improved the resistance to pitting corrosion when the samples were immersed in hydrochloric acid and also enhanced the adhesion of the coating. Xi et al. [39], investigated the influence of annealing on the mechanical behavior of TiN coating developed using unbalanced magnetron sputtering, reported that the mechanical properties were enhanced by the annealing treatment. Jafari et al. [40] analyzed the annealing effect on the optical characteristics of TiN. Also, Ponon et al. [41], in the case of annealed TiN deposited by magnetron sputtering, observed a change in the electrical and thermal properties after performing annealing treatment. Popovic et al. [42] examined the effect of annealing TiN on the optical characteristics and agreed with other researchers that annealing treatment affects the functionality of the coating.

Although a lot of research has been done on the effect of post-deposition annealing on titanium nitride coatings, nevertheless, the effect of annealing treatment on the electrochemical properties using PDP and EIS has not been investigated. Therefore, this study aims to investigate the electrochemical behaviors of TiN coating after post-deposition annealing in Ringer’s solution. For this purpose, TiN coating was deposited on AISI 304 stainless steel using the CAE-PVD technique and electrochemical behavior evaluated using the aforementioned electrochemical tests.

2. MATERIALS AND METHODS

2.1. Coating and annealing procedure

In this study, TiN coating was deposited on AISI 304 substrate using the CAE-PVD method (DS&CA601, Yar-Nikan Saleh, Tehran, Iran). The substrates were cleaned with acetone and alcohol using an ultrasonic cleaner for 20 minutes and subsequently, the ion bombardment process with a bias pulsed-DC voltage of -800 V for 20 minutes by argon gas was applied. TiN alloy was used as the target material with a target current of 120 A was utilized. Then, the coating was conducted under the vacuum pressure of 5×10⁻⁵ torr. During the deposition process, the distance between the substrate and the target was 15 cm under temperature of 200°C. The rotation speed for the samples were set at 5 r.p.m with a deposition time of 90 minutes. It should be mentioned that a Ti interlayer was deposited between TiN coating and the substrate to achieve good adhesion of TiN coating [43]. The samples were placed in an air furnace and heated at 10°C/min until the temperature reached 400°C. Finally, annealing treatment was performed for 1 h, then cooled to room temperature inside the furnace.

2.2. Surface Characterization

The surface morphology of as-deposited and post-annealed coated specimens was measured by an scanning electronic microscope (SEM) (JEOL, JSM-840A, Tokyo, Japan). The thickness of the coating was analyzed using field emission scanning electron microscopy (FESEM) (MIRA TESCAN, Brno –Kohoutovice, Czech Republic). The present phases and crystallographic structures were clarified using an X-ray diffractometer (XRD)( Philips -PW1730, Eindhoven, Netherlands) equipped with beam monochromator copper target (Kα radiation at 30 mA and 40000 V) and a scanning angular ranging from 10 to 80° with a scanning rate of 0.05° and a 1 s step size. Panalytical X’Pert high score plus software was used to quantify the present phases and calculate the crystallite size of the samples using Scherrer’s equation. The adhesion of the coatings was investigated using Rockwell-C hardness (HRC) according to VDI 3198 by applying a force of 1471 N for 30 seconds [44].

2.3. Electrochemical measurements

The electrochemical behavior of the specimens was examined in Ringer’s solution using the autolab type III/FRA2 system conducting Nova software 1.7. The electrochemical tests (PDP and EIS measurements) were performed under an aerated condition in a three-electrode flat cell containing a Pt counter electrode, an Ag/AgCl
reference electrode, and the studied samples as working electrodes. Before performing the test, the specimens were immersed in the Ringer’s solution under the open circuit potential (OCP) condition to reach stability. Then, by applying a starting potential of -250 mV$_{Ag/AgCl}$ versus the stabilized OCP to 1.8 V$_{Ag/AgCl}$, the PDP tests were carried out with the scanning rate of 1 mV/s. The electrochemical impedance spectroscopy tests were conducted in the frequency range of 100 kHz to 10 mHz. The amplitude of the sinusoidal AC voltage employed in EIS measurements was 5 mV.

3. RESULTS AND DISCUSSION

3.1. Microstructural characterization

The surface and the cross-sectional morphology of TiN coated samples including as-deposited and annealed specimens were indicated in Fig. 1. As shown in Fig. 1, the morphology of the surface showed the typical cathodic arc deposited coating features, including micropores and macroparticles distributed on the surface of the coating [20].

As can be seen in Fig. 2, the patterns of XRD reveal the presence of TiN (NaCl structure) and Ti (hexagonal close-packed) peaks in as-deposited and annealed coatings (JCPDS no.38-1420) [45], similar patterns for TiN coatings deposited by CAE-PVD were reported by other researchers [46]. Scherrer’s equation (Eq. 1) was utilized to calculate the crystalline size (D) of the as-deposited and annealed specimens as follows [47–50]:

$$D = \frac{b\lambda}{\beta \cos \theta}$$

Where, b is the Scherrrs’s constant which, is equal to 0.9, β represents full width at half maximum (FWHM) of each peak, λ is the wavelength (=0.154 nm), and θ is the diffraction angle. As reported in Table 1, the crystallite size increased from 12 to 20 nm after post-deposition annealing treatment [40, 42].

![Fig. 1. SEM images of the surface and cross-sectional (a, b) as-deposited and (c) annealed specimens.](image-url)
This phenomenon can be due to the increase in the kinetic energy and reconfiguration of the atoms as a result of the grain boundary migration and sub-grain growth during annealing treatment [42]. The microstrain (ε) was calculated using the formula below (Eq. 2):

\[ \varepsilon = \frac{\beta}{4 \tan \theta} \]  

Williamson and Smallman’s equation (Eq. 3) was used to determine the dislocation density (δ) of the as-deposited and annealed specimens.

\[ \delta = \frac{1}{\beta^2} \]  

The values of the dislocation density and the microstrain were presented in Table 1. Considering Table 1, dislocation density and microstrain decreased after annealing treatment. This can be attributed to the increase in crystallinity and annihilation of defects [51, 52].

### Table 1. Crystallite size, microstrain, and dislocation density values of as-deposited and annealed specimens

<table>
<thead>
<tr>
<th>Sample</th>
<th>Crystallite size (nm)</th>
<th>Dislocation density ((10^{-15}\text{line/m}^2))</th>
<th>Macro strain ((10^{-3}))</th>
</tr>
</thead>
<tbody>
<tr>
<td>As-deposited</td>
<td>12</td>
<td>6.9</td>
<td>7.98</td>
</tr>
<tr>
<td>Annealed ((400^\circ\text{C}))</td>
<td>20</td>
<td>2.5</td>
<td>5.79</td>
</tr>
</tbody>
</table>

3.2. **Adhesion tests**  
As mentioned before, the quality of adhesion of the coatings was evaluated based on VDI 3198 indentation test [44]. In the present study, the surface of the samples has been loaded with a Rockwell-C indenter and the vestiges of the indenter evaluated using optical microscope (OM) images (Fig. 3). Considering Fig. 3, no vestiges of delamination and cracks (correspond to HF1 class adhesion) were displayed by both coatings. It can be noted that the effect of annealing treatment on the adhesion of the TiN coatings is inappreciable [38].

3.3. **Electrochemical analysis**  
The Nyquist and Bode plots of as-deposited and annealed specimens after an immersion time of 24 and 168 h in Ringer’s solution under OCP conditions were displayed in Fig. 4.
As can be seen in the Nyquist plots of Fig. 4 (a and c), by annealing treatment, the polarization resistance of the coating increased. Also, the diameter of the semi-circles of the studied samples increased by immersion time, implying that the corrosion resistance was enhanced [53, 54]. Considering the Bode phase plots of Fig. 4 (b and d), it is clear that the maximum phase angles (MPAs) are lower than 90°. This behavior is ascribed to the non-ideal capacitor or constant phase element (CPE). Therefore, it is necessary to use CPE for fitting and simulating the experimental EIS data [54]. It is reported that the presence of CPE in CAE-PVD coatings is due to the surface heterogeneity of the coating as a result of macroparticles and micropores [55].
The impedance of CPE can be expressed as follows [24]:

\[ Z = \frac{1}{Q(j\omega)^n} \]  

(4)

where \( Q \) signifies the CPE constant, \( j \) is the imaginary number \((j^2 = -1)\), \( \omega \) represents the angular frequency (in radian per second), and \( n \) accounts for frequency-dependent parameter which varies with the surface roughness and defects present on the surface of the coating [35].

The validation of the experimental EIS tests is dependent on the stability of the electrochemical system during recording EIS spectra. Therefore, the EIS system should fulfill three requirements of linear system theory (LST) including causality, stability, and linearity.

Failure to fulfill these triple requirements discredits the EIS data [56]. For this purpose (reliability of EIS data), it is common to use Kramers-Kronig transformations (KKTs). The KKTs were employed on the experimental EIS data by transforming the imaginary \((Z')\) and the real \((Z)\) axes to the real and the imaginary axes, respectively, to compare and contrast the obtained transformed quantities and the experimental EIS data. As shown in Fig. 5, the experimental EIS data and transformed results overlapped one another that accredits the validation of the recorded experimental EIS data [53]. In this study, the electrical equivalent circuit (EEC), characterized by two-time constants, as illustrated in Fig. 4 [57]. The same EEC has been employed by other researchers to fit and simulate experimental EIS data for mono and multilayer nitride coatings [24, 55, 58–60].

In Fig. 6, \( R_s \) signifies the solution resistance, \( R_{por} \) denotes the coating resistance due to the presence of pores, and \( R_{ct} \) accounts for the charge transfer resistance between the coating and the substrate interface, \( CPE_{por} \) and \( CPE_{dl} \) are representative of the capacitance of the coating and the double layer capacitance, respectively [57]. The electrical parameters obtained by fitting the experimental data according to EEC shown in Fig. 6, were summarized in Table 2. According to the presented data, \( R_p \) for the annealed coating was greater than that of the as-deposited coating for both immersion times. In addition, for each sample, the corrosion resistance increased as the immersion time increased.

Fig. 5. KKTs of the EIS data acquired for (a, b) as-deposited and (c, d) annealed specimens after (a, c) 24 h and (b, d) 168 h of stabilization in Ringer’s solution.
Table 2. EIS parameters of as-deposited and annealed specimens according to immersion time in Ringer’s electrolyte acquired by EEC simulation.

<table>
<thead>
<tr>
<th>Sample</th>
<th>Immersion time (h)</th>
<th>Rs (Ω.cm²)</th>
<th>Rpor (kΩ.cm²)</th>
<th>CPEpor (Sα/Ω.cm⁻²) n1</th>
<th>Rct (MΩ.cm²)</th>
<th>CPEdl (Sα/Ω.cm⁻²) n2</th>
<th>Rp χ²</th>
</tr>
</thead>
<tbody>
<tr>
<td>As-deposited</td>
<td>24</td>
<td>113</td>
<td>2.10</td>
<td>0.75</td>
<td>0.88</td>
<td>3.3</td>
<td>0.021</td>
</tr>
<tr>
<td></td>
<td>168</td>
<td>112</td>
<td>2.13</td>
<td>0.68</td>
<td>0.88</td>
<td>19.1</td>
<td>0.035</td>
</tr>
<tr>
<td>Annealed (400°C)</td>
<td>24</td>
<td>111</td>
<td>2.10</td>
<td>0.61</td>
<td>0.87</td>
<td>86.9</td>
<td>0.090</td>
</tr>
<tr>
<td></td>
<td>168</td>
<td>112</td>
<td>2.30</td>
<td>0.53</td>
<td>0.88</td>
<td>173.0</td>
<td>0.079</td>
</tr>
</tbody>
</table>

Fig. 6. EEC for fitting experimental EIS data of as-deposited and annealed specimens.

Table 3. PDP data of as-deposited and annealed specimens according to immersion time in Ringer’s electrolyte.

<table>
<thead>
<tr>
<th>Sample</th>
<th>Ecorr (mV)</th>
<th>icorr (μA.cm⁻²)</th>
</tr>
</thead>
<tbody>
<tr>
<td>As-deposited</td>
<td>-6.5</td>
<td>0.014</td>
</tr>
<tr>
<td>Annealed (400°C)</td>
<td>-38.0</td>
<td>0.013</td>
</tr>
</tbody>
</table>

The annealed sample exhibited a higher corrosion potential of -38 mV and a lower current corrosion density (0.013 μA.cm⁻²) than that of the as-deposited sample. The results from the PDP are in good agreement with the EIS results, represent that post-deposition annealing improved the resistance of the coating.

According to the aforementioned results, the difference in the electrochemical behavior of as-deposited and annealed samples can be ascribed to the change in the defects on the surface [61], relaxation of stress [62], and probable TiO₂ formation [38].

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The decrease in the porosity due to the grains growth kinetics and vacancy diffusion model
reduces the possible infiltration path of the solute [63]. Furthermore, the densification of the coating increased the corrosion resistance [64]. In addition, the increase in crystallite size effectively reduced the grain boundary area and decreased corrosion initiation sites [65]. SEM observations were performed to compare the surface of the coating before and after the electrochemical test. As shown in Fig. 8, there was no evidence of pitting, crevice, or galvanic corrosion on the surface of as-deposited and annealed samples. Therefore, the annealed coating is durable for a long time when exposed to Ringer’s solution.

Fig. 8. Surface SEM images of (a) as-deposited and (b) annealed specimens after electrochemical analysis in Ringer’s solution.

4. CONCLUSIONS

This study aimed to investigate the effects of the post-annealing treatment on TiN coating. The post-deposition annealing treatment was conducted at 400°C. TiN coating was deposited on AISI 304 substrate using the CAE-PVD method. The surface morphology of the as-deposited and annealed coating showed the presence of macroparticles and pinhole distributed on the surface of the coatings. The XRD analysis showed the presence of TiN and Ti phases with NaCl and hexagonal structure, respectively. Due to the thermal treatment, dislocations density in the coating decreased resulting in the decrease in microstrain. The quality of the coating was satisfactory as there were no cracks or areas of delamination after the adhesion test. The crystallite size increased as a result of annealing treatment. KKT transformation confirmed the validity of the obtained data according to LST theory. The electrochemical tests indicated that annealed coatings had better corrosion resistance with an increase of 9% and had more protective properties than that of as-deposited coatings, which was primarily due to the decrease in porosity, increase in the grain size which decreased the active anodic area. In a nutshell, the results indicates that the annealing treatment can improve the electrochemical performance of TiN coating in Ringer’s solution and decrease the microstrain without compromising the integrity of the coating.

5. REFERENCES


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